

CALL FOR PAPERS

KEY DATES

ABSTRACT SUBMISSION DEADLINE

May 3, 2026

AUTHOR NOTIFICATION

June 21, 2026

PUBLICATION SUBMISSION DEADLINE

September 20, 2026

CONFERENCE DATE

October 4–8, 2026

ORGANIZING COMMITTEE

GENERAL CHAIRS

Omer Oralkan
Caterina Gallippi

FINANCE CHAIR

Christine Demore

TECHNICAL PROGRAM CHAIRS

Helen Mulvana
Xiaoning Jiang

SHORT COURSE CHAIRS

Kathy Nightingale
Gianmarco Pinton
Mark Palmeri

EXHIBITS & SPONSORS CHAIRS

Richard Lopata
Holly Lay

AUDIVISUAL ARRANGEMENTS

Pengfei Song

WOMEN IN ENGINEERING CHAIRS

Marie Muller
Hong Chen

PARTICIPANT EXPERIENCE CHAIRS

Kennita Johnson
Juve Ormachea

TECHNICAL CHALLENGE CHAIRS

Emma Harris
Jonathan Mamou

LABORATORY TOURS CHAIR

Virginie Papadopoulou

WEBSITE, APP & PUBLICITY CHAIRS

Dominique Certon
Jenny Lee
Michael Oelze

STUDENT EVENTS CHAIRS

Yun Jing
Koen van Dongen

LOCAL ARRANGEMENTS CHAIR

Yalcin Yamaner
Junjie Yao

PUBLICATIONS & PROCEEDINGS CHAIR

Steven Freear
Sevan Harput

WORKSHOPS & PANELS CHAIRS

Jean Provost
Jeremy Dahl

The 2026 IEEE International Ultrasonics Symposium, the 63rd edition of this premier conference, will take place on October 4–8, 2026, in Raleigh, North Carolina, USA. Known as the “City of Oaks,” Raleigh combines historic Southern charm with a thriving spirit of innovation. At the heart of North Carolina’s renowned Research Triangle, the city sits at the center of one of the world’s most active clusters of ultrasound research and development, supported by leading universities, research hospitals, and technology companies that are advancing breakthroughs in healthcare and engineering. Visitors can enjoy a vibrant culinary and music scene, as well as convenient access to both the Blue Ridge Mountains and the Atlantic coast. The conference will be hosted at the Raleigh Convention Center, located in the heart of downtown and within walking distance of restaurants, breweries, live music venues, green spaces, and cultural attractions, offering participants an engaging and accessible setting. Just 20 minutes from Raleigh–Durham International Airport, the venue provides seamless access to both business and leisure opportunities. The symposium will emphasize the value of in-person engagement while also providing a virtual attendance option to ensure global participation.

SUBMISSION TOPICS

Abstracts should be submitted according to the information posted on the conference web page. Each abstract will receive careful review and evaluation by the symposium Technical Program Committee based on originality of the work, contribution to the state of the art and overall interest to the ultrasonics community. Papers are solicited describing original work in the field of ultrasonics.

- » Group 1: Medical Ultrasonics
- » Group 2: Sensors, NDE & Industrial Applications
- » Group 3: Physical Acoustics
- » Group 4: Microacoustics – SAW, FBAR & MEMS
- » Group 5: Transducers & Transducer Materials

STUDENT PAPER COMPETITION AND TRAVEL SUPPORT

Students submitting abstracts are invited to participate in a student paper competition. To participate, the student must be the lead author and present their paper. Limited funds are available to support travel for IEEE UFFC student member attendees at the 2026 symposium. Awards will be given on a competitive basis.



For more information please visit ieee-ius.org.